



# THE DATASHEET OF BAS521-7



## Features

- Fast Switching Speed: max. 50 ns
- High Reverse Breakdown Voltage: 300V
- Low Leakage Current: 100nA at room temperature
- Ultra Small Plastic SMD Package
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**

## Mechanical Data

- Case: SOD-523
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: Cathode Bar
- Terminals: Finish - Matte Tin annealed over Alloy 42 leadframe.
- Solderable per MIL-STD-202, Method 208
- Weight: 0.0014 grams (approximate)

SOD523



Top View



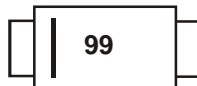
Device Schematic

## Ordering Information (Note 4)

Part Number	Case	Packaging (Note 5)
BAS521-7	SOD523	3000/Tape & Reel
BAS521-13	SOD523	10000/Tape & Reel

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
  2. See <http://www.diodes.com> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
  3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
  4. For packaging details, go to our website at <http://www.diodes.com/datasheets/ap02007.pdf>.
  5. Dispensed in every other cavity of the tape.

## Marking Information



99 = Product Type Marking Code  
Bar Denotes Cathode Side

**Maximum Ratings** (@ $T_A = +25^\circ\text{C}$ , unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Repetitive Peak Reverse Voltage	$V_{RRM}$	300	V
Working Peak Reverse Voltage	$V_{RWM}$	300	V
DC Blocking Voltage			
Forward Current (Note 6)	$I_F$	250	mA
Non-Repetitive Peak Forward Surge Current @ $t = 1.0\mu\text{s}$	$I_{FSM}$	4.5	A
Repetitive Peak Forward Current (Note 6)	$I_{FRM}$	1	A

**Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 6)	$P_D$	325	mW
Thermal Resistance Junction to Ambient Air (Note 6)	$R_{\theta JA}$	385	$^\circ\text{C/W}$
Operating and Storage Temperature Range	$T_J, T_{STG}$	-65 to +150	$^\circ\text{C}$

**Electrical Characteristics** (@ $T_A = +25^\circ\text{C}$ , unless otherwise specified.)

Characteristic	Symbol	Min	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 7)	$V_{(BR)R}$	300	—	V	$I_R = 100\mu\text{A}$
Forward Voltage	$V_F$	—	1.1	V	$I_F = 100\text{mA}$
Reverse Current (Note 7)	$I_R$	—	50	nA	$V_R = 5\text{V}$
		—	150	nA	$V_R = 250\text{V}$
		—	100	$\mu\text{A}$	$V_R = 250\text{V}, T_J = +150^\circ\text{C}$
Total Capacitance	$C_T$	—	5	pF	$V_R = 0, f = 1.0\text{MHz}$
Reverse Recovery Time	$t_{rr}$	—	50	ns	$I_F = I_R = 30\text{mA}, I_{rr} = 0.1 \times I_R, R_L = 100\Omega$

Notes: 6. Part mounted on FR-4 board with recommended pad layout, which can be found on our website at <http://www.diodes.com>.  
7. Short duration pulse test used to minimize self-heating effect.

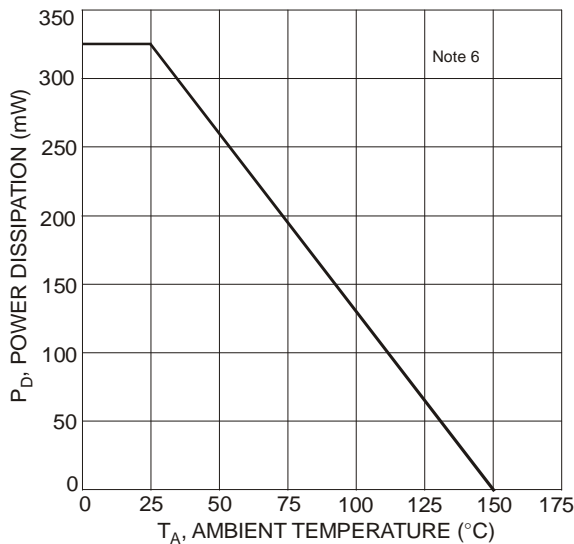


Fig. 1 Power Derating Curve, Total Package

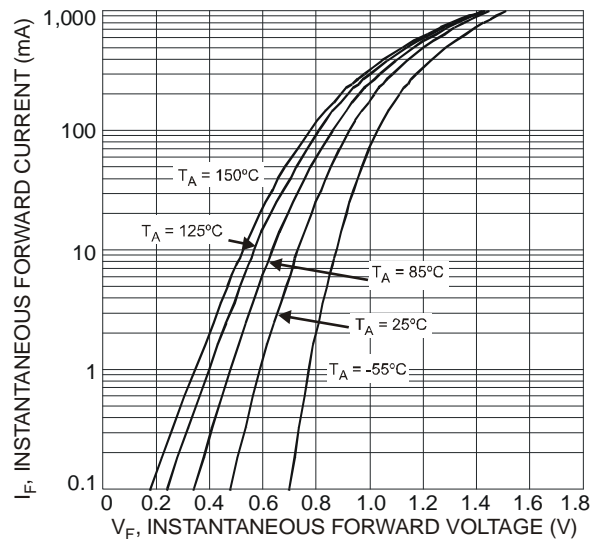


Fig. 2 Typical Forward Characteristics, Per Element

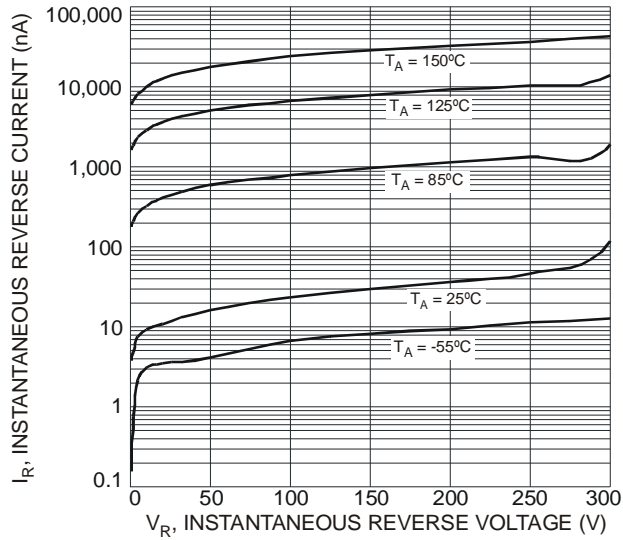


Fig. 3 Typical Reverse Characteristics, Per Element

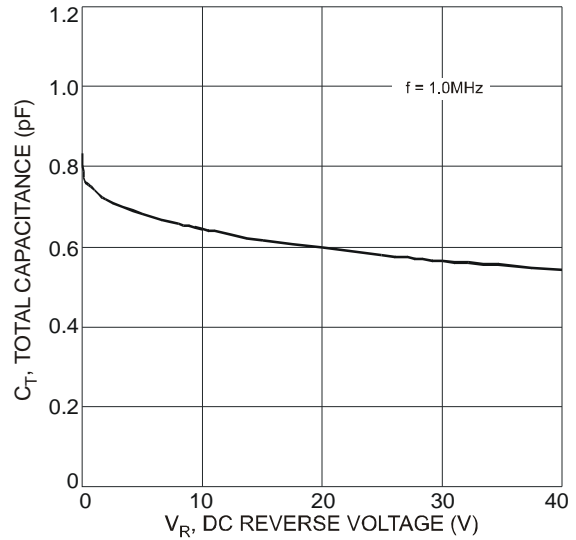
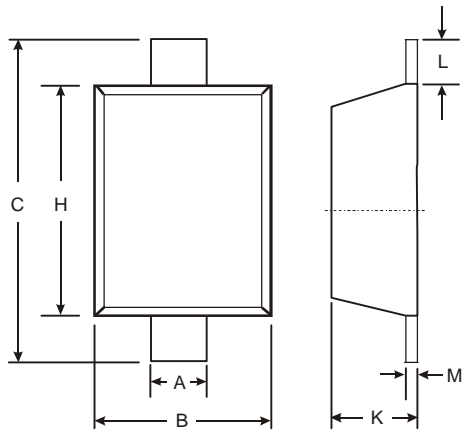


Fig. 4 Total Capacitance vs. Reverse Voltage, Per Element

## Package Outline Dimensions

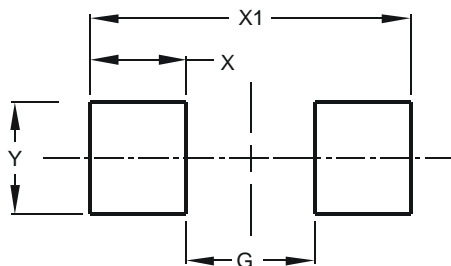
Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for latest version.



SOD523		
Dim	Min	Max
A	0.25	0.35
B	0.70	0.90
C	1.50	1.70
H	1.10	1.30
K	0.55	0.65
L	0.10	0.30
M	0.10	0.12
All Dimensions in mm		

## Suggested Pad Layout

Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for the latest version.



Dimensions	Value (in mm)
G	0.80
X	0.60
X1	2.00
Y	0.70

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